

# ESDALC5-1BT2Y

Datasheet – production data

### Automotive single-line low capacitance Transil™, transient surge voltage suppressor (TVS) for ESD protection



### Features

- Single-line bidirectional protection
- Breakdown voltage = 5.8 V min.
- Low capacitance = 26 pF at 0 V •
- Lead-free packages
- ECOPACK<sup>®</sup>2 compliant component
- AEC-Q101 qualified •

#### **Benefits**

- Low capacitance for optimized data integrity
- Low leakage current < 60 nA
- Low PCB space consumption: 0.6 mm<sup>2</sup>
- High reliability offered by monolithic integration •

#### Complies with the following standards:

- IEC 61000-4-2 (exceeds level 4)
  - 30 kV (air discharge)
  - 30kV (contact discharge)
- ISO10605: C = 330 pF, R = 330 Ω
  - 30kV (air discharge)
  - 30kV (contact discharge)
- ISO 7637-3:

February 2014

- Pulse 3a: V<sub>S</sub> = -150 V
- Pulse 3b: V<sub>S</sub> = +100 V

**Applications** 

Where transient overvoltage protection in ESD sensitive equipment is required, such as:

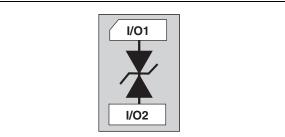
- Automotive applications
- Computers
- **Printers**
- Communication systems
- Cellular phone handsets and accessories
- Video equipment

### Description

The ESDALC5-1BT2Y is bidirectional single-line TVS diode designed to protect data lines or other I/O ports against ESD transients.

This device is ideal for applications where both printed circuit board space and power absorption capability are required.

#### Figure 1. Functional diagram



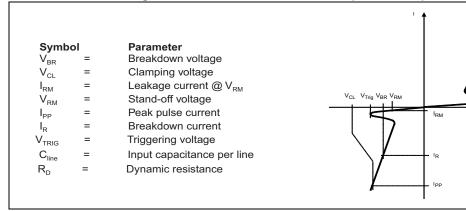
TM: Transil is a trademark of STMicroelectronics

## 1 Characteristics

Symbol	Parameter			Value	Unit
		IEC 61000-4-2 contact discharge		30	
		IEC 61000-4-2 air discharge		30	kV
V <sub>PP</sub>	Peak pulse voltage	ISO10605 contact discharge		30	
		ISO10605 air discharge		30	
		MIL STD 883G - Method	25		
P <sub>PP</sub>	Peak pulse power di	Peak pulse power dissipation (8/20 $\mu$ s) T <sub>j</sub> initial = T <sub>amb</sub>		150	W
I <sub>PP</sub>	Peak pulse current (	Peak pulse current (8/20 μs)			А
Т <sub>ОР</sub>	Operating junction temperature range			- 50 to + 125	°C
T <sub>stg</sub>	Storage temperature range			- 65 to + 125	°C
TL	Maximum lead temperature for soldering during 10 s			260	°C

Table 1. Absolute maximum rating	s (T <sub>amb</sub> = 25 °C)
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#### Figure 2. Electrical characteristics (definitions)



Symbol	Test condition	Min.	Тур.	Max.	Unit
V	From I/O1 to I/O2, I <sub>R</sub> = 1 mA	11	13	17	V
$V_{BR}$	From I/O2 to I/O1, I <sub>R</sub> = 1 mA	5.8	8	11	v
I <sub>RM</sub>	V <sub>RM</sub> = 5 V			60	nA
R <sub>d</sub>	Dynamic resistance, pulse width 100 ns R <sub>d</sub> From I/O1 to I/O2 From I/O2 to I/O1		0.25 0.23		Ω
V <sub>CL</sub>	8 kV contact discharge after 30 ns IEC 61000 4-2 From I/O1 to I/O2 From I/O2 to I/O1		17.5 12.5		V
C <sub>line</sub>	F = 1 MHz, V <sub>R</sub> = 0 V		26	30	pF

Table 2. Electrical characteristics	(values, T <sub>amb</sub> = 25 °C)
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Figure 3. Peak pulse power versus initial junction temperature (maximum values)

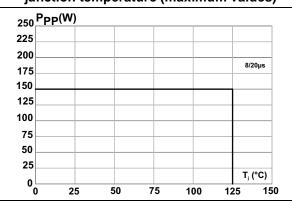


Figure 5. Peak pulse power versus exponential pulse duration (maximum values)

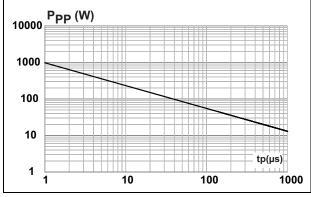
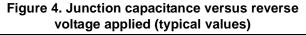


Figure 7. Clamping voltage versus peak pulse current (typical values)



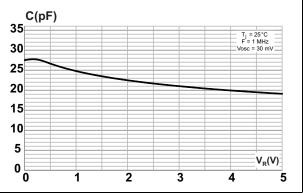


Figure 6. Clamping voltage versus peak pulse current (typical values)

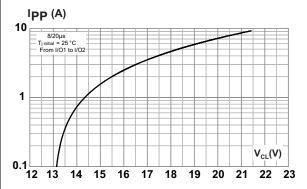


Figure 8. Leakage current versus junction temperature (typical values)

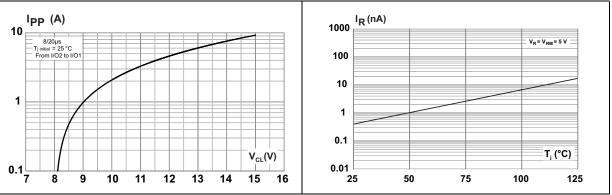




Figure 9. S21 attenuation measurement

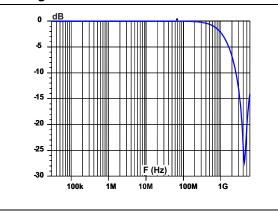


Figure 11. ESD response to ISO 10605, C = 150 pF, R =  $330 \Omega$  (+8 kV contact)

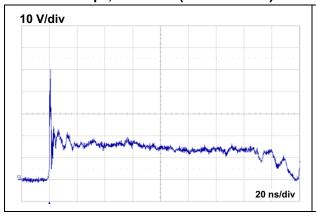


Figure 13. Response to ISO 7637-3 (pulse 3a) U<sub>S</sub> = -150 V

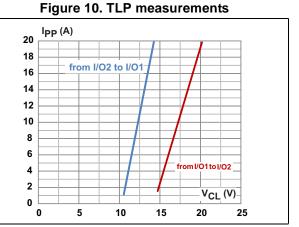


Figure 12. ESD response to ISO 10605, C = 150 pF, R = 330  $\Omega$  (-8 kV contact)

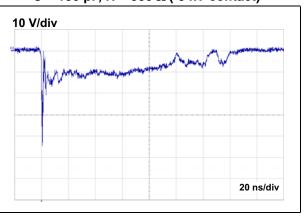
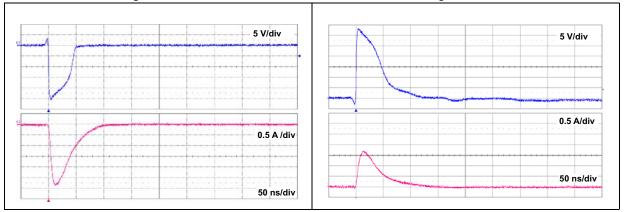


Figure 14. Response to ISO 7637-3 (pulse 3b)  $U_S = +100 V$ 





### 2 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK<sup>®</sup> is an ST trademark.

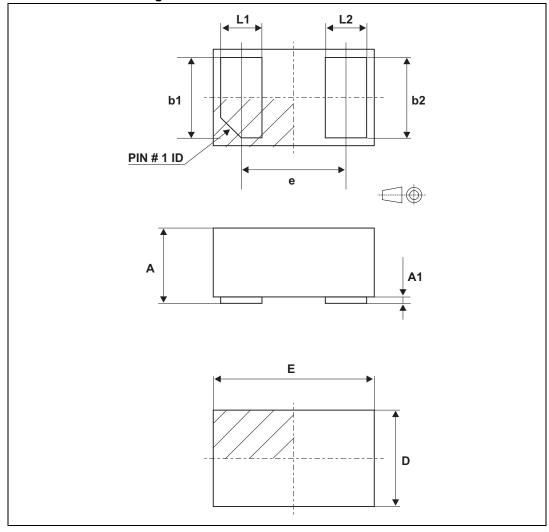


Figure 15. SOD882T dimension definitions



	Dimensions							
Ref.	Millimeters			Inches				
	Min.	Тур.	Max.	Min.	Тур.	Max.		
А	0.30		0.40	0.012		0.016		
A1	0.00		0.05	0.000		0.002		
b1	0.45	0.50	0.55	0.018	0.020	0.022		
b2	0.45	0.50	0.55	0.018	0.020	0.022		
D	0.55	0.60	0.65	0.022	0.024	0.026		
Е	0.95	1.00	1.05	0.037	0.039	0.041		
е	0.60	0.65	0.70	0.024	0.026	0.028		
L1	0.20	0.25	0.30	0.008	0.010	0.012		
L2	0.20	0.25	0.30	0.008	0.010	0.012		

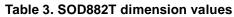
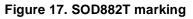
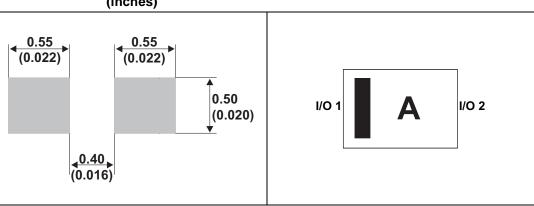


Figure 16. SOD882T footprint in mm (inches)

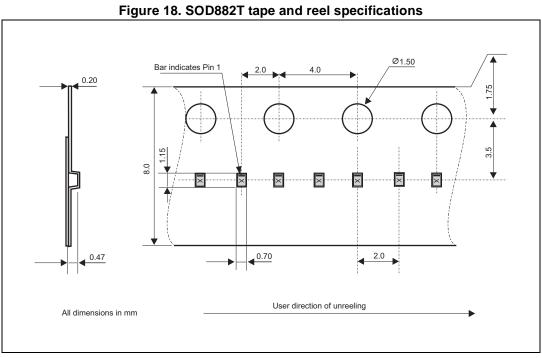




Note:

Product marking may be rotated by multiples of 90° for assembly plant differentiation. In no case should this product marking be used to orient the component for its placement on a PCB. Only pin 1 mark is to be used for this purpose.





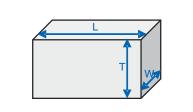


### 3 Recommendation on PCB assembly

### 3.1 Stencil opening design

- 1. General recommendation on stencil opening design
  - a) Stencil opening dimensions: L (Length), W (Width), T (Thickness).

#### Figure 19. Stencil opening dimensions



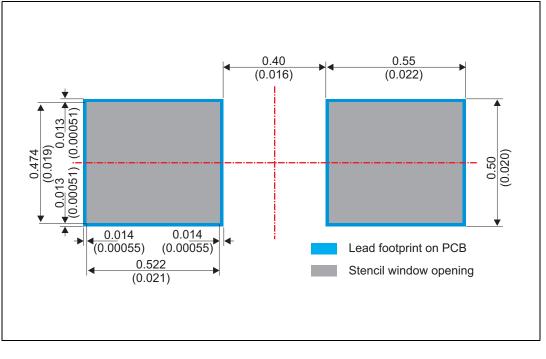
#### b) General design rule

Stencil thickness (T) = 75 ~ 125 µm

Aspect Ratio = 
$$\frac{W}{T} \ge 1,5$$

Aspect Area = 
$$\frac{L \times W}{2T(L + W)} \ge 0,66$$

- 2. Reference design
  - a) Stencil opening thickness: 100 µm
  - b) Stencil opening for central exposed pad: Opening to footprint ratio is 50%.
  - c) Stencil opening for leads: Opening to footprint ratio is 90%.



#### Figure 20. Recommended stencil window position in mm (inches)

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#### 3.2 Solder paste

- 1. Halide-free flux qualification ROL0 according to ANSI/J-STD-004.
- 2. "No clean" solder paste is recommended.
- 3. Offers a high tack force to resist component movement during high speed.
- 4. Solder paste with fine particles: powder particle size is 20-45  $\mu$ m.

#### 3.3 Placement

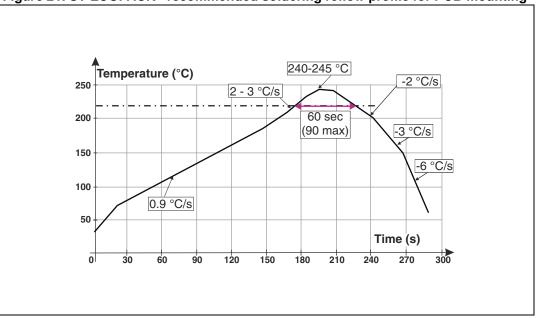
- 1. Manual positioning is not recommended.
- 2. It is recommended to use the lead recognition capabilities of the placement system, not the outline centering.
- 3. Standard tolerance of  $\pm$  0.05 mm is recommended.
- 4. 3.5 N placement force is recommended. Too much placement force can lead to squeezed out solder paste and cause solder joints to short. Too low placement force can lead to insufficient contact between package and solder paste that could cause open solder joints or badly centered packages.
- 5. To improve the package placement accuracy, a bottom side optical control should be performed with a high resolution tool.
- 6. For assembly, a perfect supporting of the PCB (all the more on flexible PCB) is recommended during solder paste printing, pick and place and reflow soldering by using optimized tools.

### 3.4 PCB design preference

- 1. To control the solder paste amount, the closed via is recommended instead of open vias.
- 2. The position of tracks and open vias in the solder area should be well balanced. The symmetrical layout is recommended, in case any tilt phenomena caused by asymmetrical solder paste amount due to the solder flow away.



### 3.5 Reflow profile



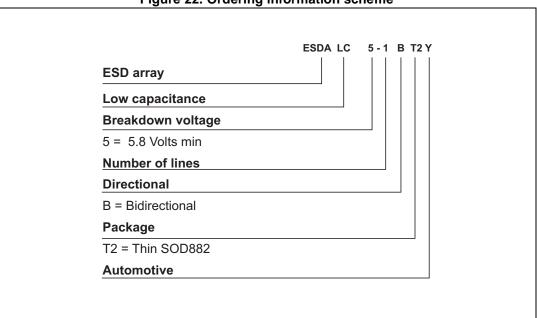




Minimize air convection currents in the reflow oven to avoid component movement.



### 4 Ordering information



#### Figure 22. Ordering information scheme

#### Table 4. Ordering information

Order code Marking <sup>(1)</sup>		Package	Weight	Base qty	Delivery mode
ESDALC5-1BT2Y	А	SOD882T	0.80 mg	12000	Tape and reel

1. The marking can be rotated by multiples of  $90^\circ$  to differentiate assembly location

### 5 Revision history

#### Table 5. Document revision history

	Date	Revision	Changes		
ĺ	03-Feb-2014	1	Initial release.		



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